

# Substrate Integrated Waveguide Filter with Improved Stopband Performance Using LTCC Technology

Ping-Juan Zhang<sup>1, \*</sup> and Min-Quan Li<sup>2</sup>

**Abstract**—A novel multi-layer third-order substrate integrated waveguide (SIW) bandpass filter with improved lower stopband performance is proposed.  $TE_{201}$ -mode in folded-SIW cavity is utilized to implement negative cross coupling, and the  $TE_{101}$ -mode is taken as a non-resonating node (NRN) for implementing bypass coupling. A circular aperture etched on the middle metal layer is used to realize coupling between source and the second SIW cavity. Then, three transmission zeros located below the passband can be obtained to improve stopband attenuation. Meanwhile, better spurious suppression performance above passband is achieved. A filter sample is designed and fabricated with multi-layer low-temperature co-fired ceramic (LTCC) technology. The measured  $S$ -parameters agree well with the simulated ones, with its predicted good performance.

## 1. INTRODUCTION

The demand for microwave filters having high performances and low costs is increasing in the wireless communication systems. Various methods emerged due to the needs for stringent requirements on in-band and out-of-band performances, such as low loss, high selectivity, and high rejection. Waveguide filters have been widely used in various microwave communication systems, due to their high  $Q$ -factors and high power capability. Substrate integrated waveguide (SIW), implemented by planar dielectric substrate with linear arrays of metallic via-holes embedded, has attracted much interest due to advantages of high  $Q$ -factor, low loss, high power capacity, and easy to be integrated with other planar circuits [1].

Many techniques have been applied to various SIW filter designs to obtain better performances in the past several years [2–22]. In order to improve the slope selectivity of the SIW filters, cross couplings are introduced into planar arranged and vertical stacked SIW filters for quasi-elliptic responses [2–5]. Evanescent-mode SIW filters implemented with CSRRs have compact size, better frequency selectivity and better attenuation in the higher stopbands [8–10].

In conventional trisection configuration, a transmission zero (TZ) placed above the passband can be realized in SIW filter [11]. In order to move TZ to the lower stopband,  $TE_{201}$ -mode in SIW cavity is used to filter design [12], and then, larger sizes are inevitable. To get a negative cross-coupling in trisection topology, coplanar waveguide (CPW) structure is etched on the top metal layer of the SIW cavities [13, 14]. Nonphysical couplings implemented by higher or lower modes in waveguides are used to generate the finite TZs far away from the passband for improved stopband performance [15]. Oversized SIW  $TE_{101}/TE_{201}$  cavity or  $TE_{101}/TE_{301}$  cavity can be used as a singlet to generate multiple TZs located below or above the passband for sufficient stopband attenuation [16, 17]. Three TZs located above the passband can be introduced by cascading two dual-mode SIW filters in mutli-layer technology [18]. In the fourth-order filter, additional TZ generated by mixed cross coupling is used to improve selectivity and the higher stopband performance [19]. Furthermore, mixed source and load coupling is introduced

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into SIW dual mode filter, and two TZs placed below passband are generated [20]. Extended doublet topology with two TZs above the passband is presented in [21] for better high stopband performance.

In this paper, a third-order SIW bandpass filter with three TZs located below the passband is presented. To realize the negative cross coupling, TE<sub>201</sub>-mode in the folded-SIW cavity is utilized to filter design. The corresponding TE<sub>101</sub>-mode is taken as non-resonator node (NRN) which provides a bypass of signal energy. An aperture etched on the middle metal layer of two SIW cavities is used to achieve multiple paths between source and load. A SIW filter sample is design and fabricated by low-temperature co-fired ceramic (LTCC) technology, and the measured  $S$ -parameters agree well with the simulated counterparts.

## 2. FILTER DESIGN

### 2.1. Coupling Scheme of Filter

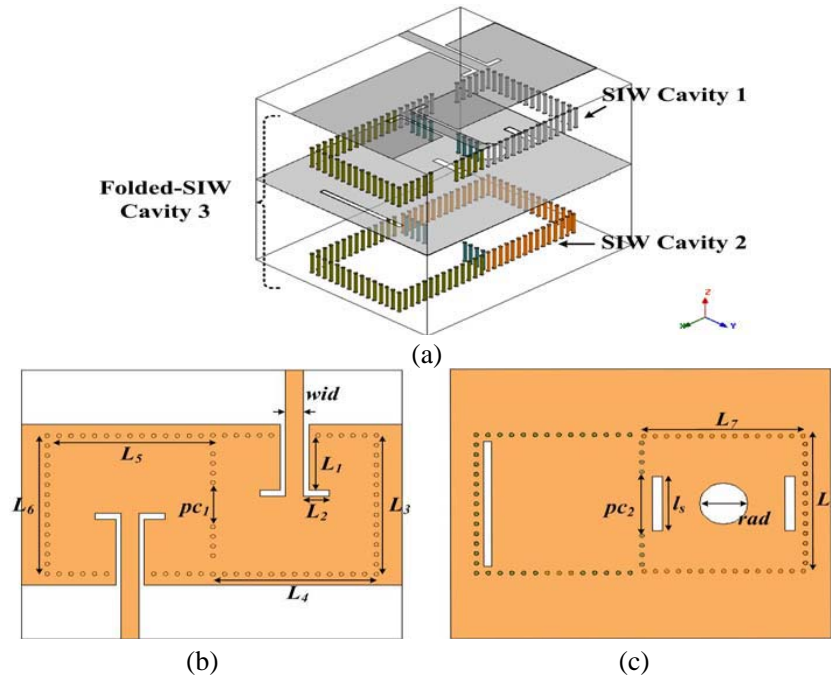
Figures 1(a), (b) and (c) show the three-dimensional view, top and middle metal layers of the proposed SIW filter, respectively. The corresponding topology is shown in Figure 2, and the corresponding coupling matrix  $M$  can be written as

$$\begin{bmatrix} 0 & M_{S1} & M_{S2} & 0 & 0 & 0 \\ M_{S1} & M_{11} & M_{12} & M_{13} & M_{14} & 0 \\ M_{S2} & M_{12} & M_{22} & M_{23} & M_{24} & 0 \\ 0 & M_{13} & M_{23} & M_{33} & 0 & M_{3L} \\ 0 & M_{14} & M_{24} & 0 & M_{44} & M_{4L} \\ 0 & 0 & 0 & M_{3L} & M_{4L} & 0 \end{bmatrix} \quad (1)$$

where diagonal elements in the coupling matrix are calculated by [22]:

$$M_{i,i} = (f_0^2 - f_i^2) / (\Delta f \cdot f_i) \quad (2)$$

Here, parameters  $f_0$  and  $\Delta f$  are the central frequency and the bandwidth of the filter, respectively, and  $f_i$  is the resonant frequency of the  $i$ th resonator. The bandwidth and central frequency of the filter are



**Figure 1.** The (a) three-dimensional view, the (b) top, and (c) middle metal layer of the third-order SIW filter, respectively.

set to be 13.50 GHz and 1 GHz, respectively. Further, the generalized coupling matrix can be obtained using the gradient-based optimization method, and given by

$$M = \begin{bmatrix} 0 & 1.065 & 0.24 & 0 & 0 & 0 \\ 1.065 & -0.23 & 0.701 & 0.66 & 0.0035 & 0 \\ 0.24 & 0.701 & 0.99 & -0.701 & 0.012 & 0 \\ 0 & 0.66 & -0.701 & -0.23 & 0 & 1.02 \\ 0 & 0.0035 & 0.012 & 0 & 8 & 1.063 \\ 0 & 0 & 0 & 1.02 & 1.063 & 0 \end{bmatrix} \quad (3)$$

The resonator 4 in matrix (3) is taken as NRN, whose resonant frequency is far away from the central frequency of passband.

As shown in Figure 2(a), a trisection topology is given without introducing NRN. In Figure 2(b), we take nodes 3 and 4 as a singlet. If the source node in Figure 2(b) is replaced by nodes 1 and 2 in Figure 2(a), the proposed coupling scheme with NRN in Figure 2(c) can be obtained. The synthesized frequency dependent  $S$ -parameters, corresponding to the trisection, singlet and the coupling matrix  $M$  with different  $M_{44}$  are plotted in Figures 3(a) and (b).

$S$ -parameters of the trisection and singlet are plotted in Figure 3(a). The black dotted line represents the  $S$ -parameter of trisection topology, whose coupling matrix is derived from matrix  $M$  without node 4. There are two TZs located at the lower stopband. For the singlet, the coupling matrix  $M'$  is derived from matrix  $M$  without nodes 1 and 2. Then, a TZ around 10 GHz is generated by the singlet  $M'$ . Meanwhile, the synthesized  $S$ -parameter of matrix  $M$  is also plotted in Figure 3(a) for

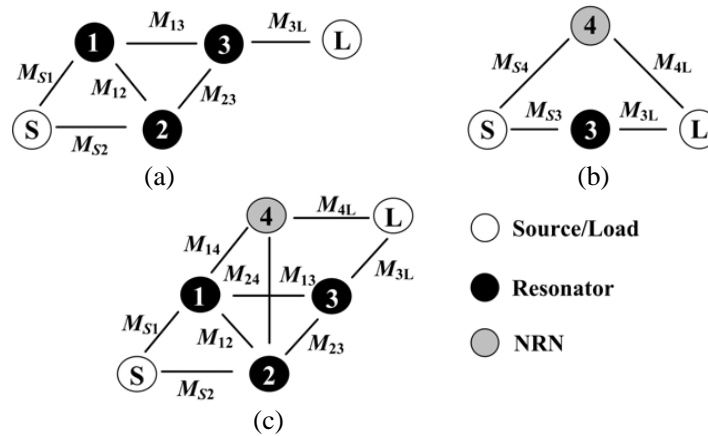


Figure 2. (a) The trisection, (b) the singlet, and (c) the topology of the proposed SIW filter.

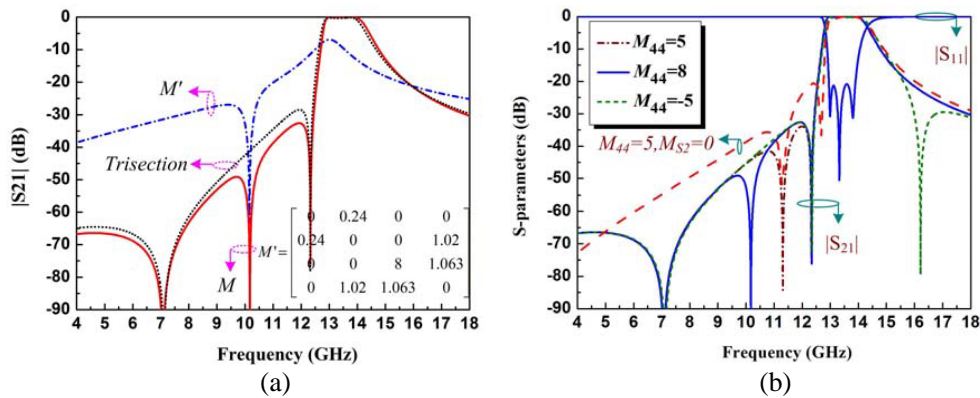


Figure 3. The frequency dependent  $S$ -parameters of (a) the trisection and singlet and (b)  $M$  with different  $M_{44}$ .

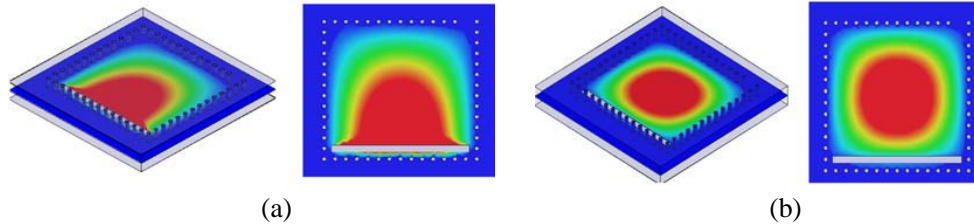
demonstrating the generation of three TZs. As shown in Figure 3(b), the TZ close to the passband is contributed to negative cross coupling in trisection topology. The lowest TZ is generated by coupling between source and cavity 2. The middle TZ is mainly controlled by the resonant frequency of NRN. If  $M_{44} > 0$ , three transmission zeros are all located at the lower stopband. When  $M_{44} < 0$ , one TZ moves from the lower to the upper stopband.

## 2.2. Filter Design

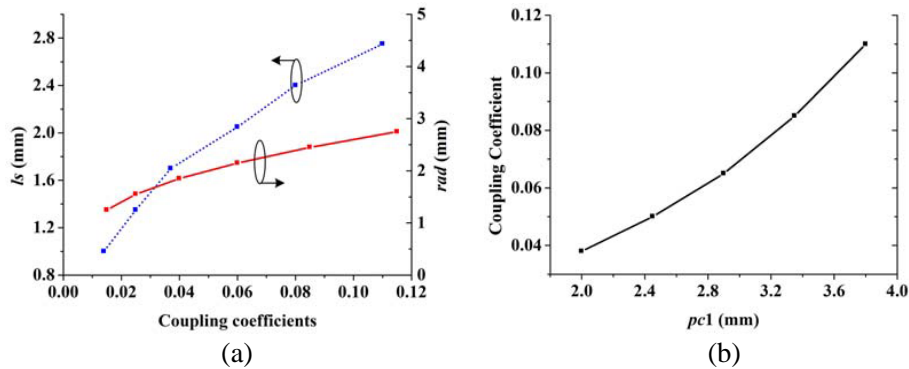
As shown in Figure 1, a folded-SIW cavity is introduced for realizing negative cross coupling and NRN. The folded-SIW cavity consists of a bottom metal layer, two dielectric layers, and in between a metal plate with a slot, a top conductor plane, and vias. It just likes a  $TE_{101}$  waveguide resonator is folded along the thickness direction. The slot allows electromagnetic fields from one half to the other of the folded SIW cavity so that the mode can be maintained. To verify this, the electric field distributions of  $TE_{101}$  and  $TE_{201}$ -modes in the folded-SIW cavity 3 are shown in Figures 4(a) and (b). For  $TE_{101}$ -mode, the electric field concentrates around the slot. Furthermore, the electric field of  $TE_{201}$ -mode reaches maximum at the center of folded-SIW cavity.  $TE_{101}$ - and  $TE_{201}$ -modes resonate around 11 GHz and 13.5 GHz, respectively. All simulated results are performed by full-wave electromagnetic simulator (High Frequency Structure Simulator, HFSS).

As shown in Figure 1(a), magnetic coupling between cavities 1 and 2 is obtained by two slots near vias, and a circular aperture is used to realize electric coupling between cavities 1 and 2. The coupling coefficients versus  $l_s$  and  $rad$  are plotted in Figure 5(a), and the coupling will become larger with increasing of  $l_s$  and  $rad$ . Two coupling iris are introduced to get couplings among cavities 1, 2 and 3.  $TE_{201}$ -mode in folded-SIW cavity is taken as a resonator for passband implement. Therefore, the signs of coupling coefficients  $M_{13}$  and  $M_{23}$  are different. Figure 5(b) plots the magnetic coupling coefficients versus  $pc_1$ . The coupling coefficients become larger with increase of  $pc_1$ .

Figure 1(a) shows that two CPW probes are used to excite the SIW cavities 1 and 3. It should be noted that the circular aperture is also introduced to bring about the coupling between input probe and cavity 2. In the design, the magnetic coupling between cavities 1 and 2 should be much larger than



**Figure 4.** The electric field distribution of the (a)  $TE_{101}$  and (b)  $TE_{201}$ -mode in the third folded-SIW cavity.



**Figure 5.** The simulated coupling coefficients versus (a)  $rad$ , (b)  $l_s$ , and (c)  $pc_1$ .

the electric coupling. The simulated external  $Q$ -factors for different values of  $L_1$  and  $rad$  are plotted in Figure 6.  $Q_{e1}$  and  $Q_{e2}$  are denoted as external factors of SIW cavities 1 and 2. As shown in Figure 6, the external  $Q$ -factor of cavity 2 is large due to its weak coupling with input probe. As  $rad$  increases,  $Q_{e2}$  will be smaller.

We use  $TE_{201}$ -mode of folded-SIW cavity 3 to design the passband and regard  $TE_{101}$ -mode as a spurious resonance. For a singlet, the input and output coupling apertures can be arranged properly to get the required sign constraints on the coupling product. Therefore, it is possible to place the TZ below or above the passband [15]. The  $TE_{201}$ -mode in the folded-SIW cavity is introduced to realize negative cross coupling. Therefore, one TZ near the passband can be realized in the trisection topology. The  $TE_{101}$ -mode in the folded-SIW cavity 3 serves as a singlet to produce the second transmission zero around 11 GHz.

Figures 7(a), (b) and (c) plot the simulated  $S_{21}$ -parameters of the proposed filter with different

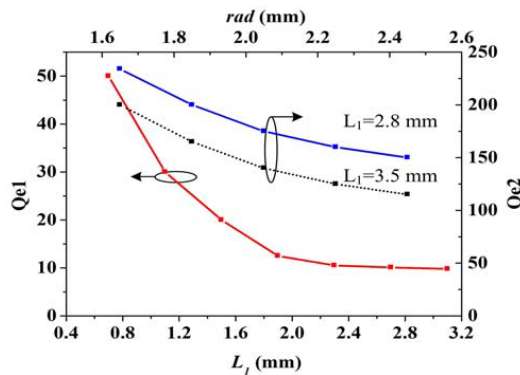


Figure 6. The simulated external  $Q$ -factors of cavity 1 and 2.

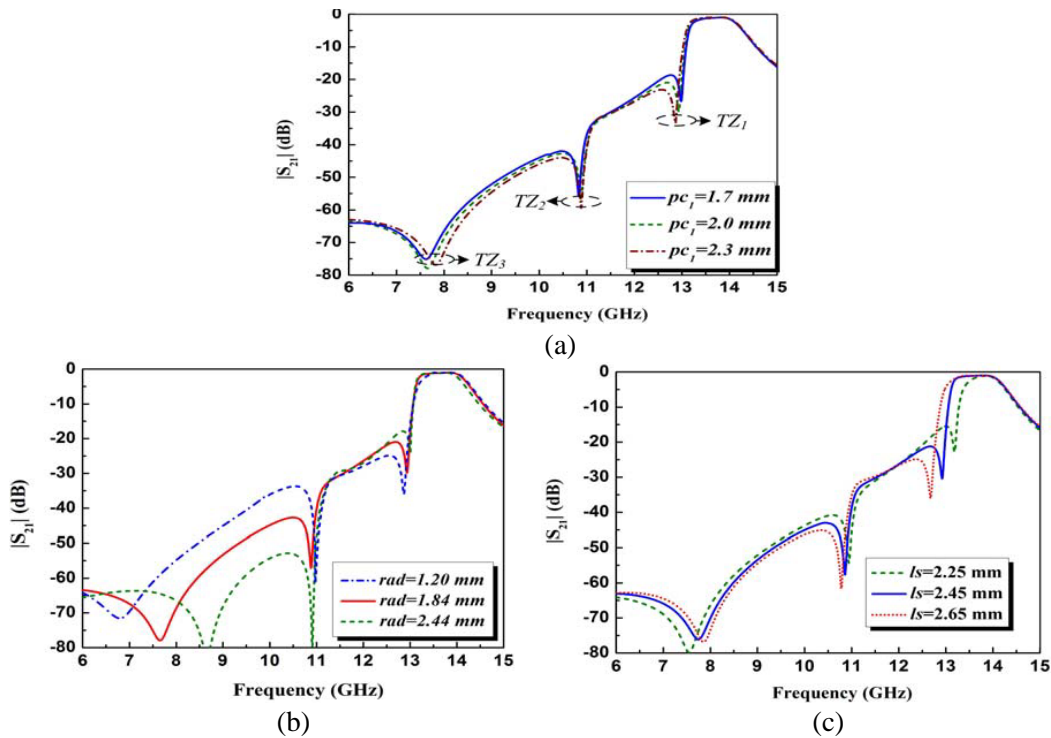
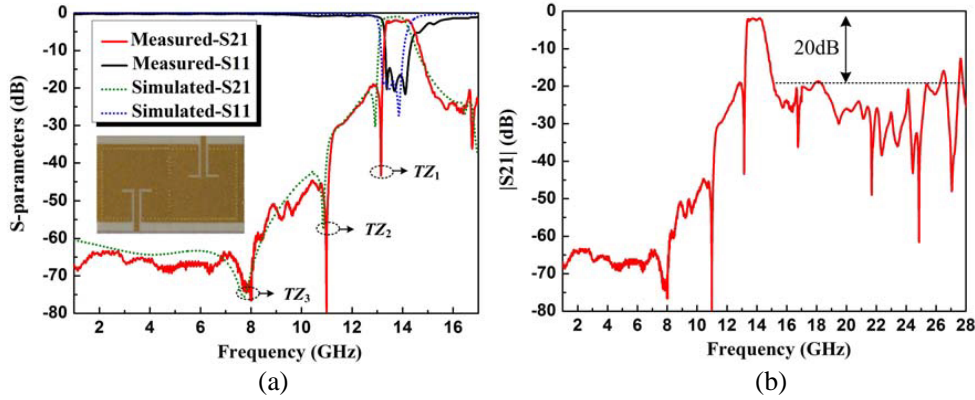


Figure 7. The simulated  $S_{21}$ -parameter as a function of frequency for different values of (a)  $pc_1$ , (b)  $rad$ , and (c)  $l_s$ .



**Figure 8.** The simulated and measured  $S$ -parameters of the filter from (a) 1 GHz to 17 GHz, and (b) 1 GHz–28 GHz.

values of  $pc_1$ ,  $rad$  and  $l_s$ , respectively. As shown in Figure 7(a), the location of  $TZ_1$  is mainly controlled by  $pc_1$ . The cross coupling will be larger with increase of  $pc_1$ , and  $TZ_1$  will move close to the passband. We can adjust the location of  $TZ_3$  by changing values of  $rad$ . As  $rad$  increases, the coupling  $M_{S2}$  becomes larger, and  $TZ_3$  will move close to the passband. In summary,  $TZ_1$  is contributed to the cross coupling, and the lowest one  $TZ_3$  is generated by introducing  $M_{S2}$ . The location of  $TZ_2$  is contributed to resonant frequency of  $TE_{101}$ -mode in SIW cavity 3.

As shown in Figure 1(c), electric and magnetic couplings both exist between SIW cavities 1 and 2. Electric coupling is obtained by the circular aperture etched on the middle metal layer, and the magnetic coupling is realized by slots around wall of via-holes. As plotted in Figure 7(b), the value of  $rad$  is fixed; the bandwidth increases with increase of  $l_s$ ; the position of  $TZ_3$  keeps unchanged.

### 3. RESULTS AND DISCUSSION

In order to validate our design, the third-order SIW filter sample was fabricated using multi-layer LTCC substrate. Its relative permittivity, loss tangent and thickness of each layer are 5.9, 0.0025 and 0.096 mm, respectively. The diameter of via-hole is 0.174 mm. Each SIW cavity occupies five LTCC layers. The geometrical parameters of the filter are listed as follows:  $L_1 = 2.8$  mm,  $L_2 = 1.0$  mm,  $L_3 = 6.33$  mm,  $L_4 = 6.33$  mm,  $L_5 = 6.4$  mm,  $L_6 = 6.3$  mm,  $L_7 = 6.16$  mm,  $L_8 = 6.16$  mm,  $pc_1 = 2.0$  mm,  $pc_2 = 2.9$  mm,  $rad = 1.85$  mm,  $wid = 0.7$  mm,  $l_s = 2.45$  mm.

A photograph of the fabricated SIW filter is given in Figure 8(a), the size of this filter is around  $14 \times 8$  mm<sup>2</sup>, i.e.,  $1.55 \times 0.9\lambda_g^2$ , where  $\lambda_g$  is the guided wavelength at the central frequency. As shown in Figure 8(a), the measured center frequency and bandwidth of the SIW filter are around 13.88 GHz and 1 GHz, respectively. The slight shift of central frequency contributes to large shrink of SIW cavities. Besides, the measured insertion and return losses in the passband are 2.1 and better than 15 dB, respectively. Three transmission zeros ( $TZ_1$ ,  $TZ_2$  and  $TZ_3$ ) located at 13.1, 11 and 8 GHz are used to get high rejection of the lower stopband. The circuit area is only 50% of a conventional planar SIW filters. The attenuated level is larger than 50 dB from DC to 10 GHz. Figure 8(b) shows the measured wideband performance. The spurious passband appears at 28 GHz, so we can say that better spurious suppression is achieved. This is due to the spurious passbands of SIW cavities 1, 2 are different from the counterparts of folded-SIW cavity 3.

### 4. CONCLUSION

In this paper, we present a compact third-order SIW LTCC filter with improved lower stopband performance.  $TE_{201}$ -mode is not only taken as phase inverter, but also combines with  $TE_{101}$ -mode of the third SIW cavity are served as a singlet. Three TZs located at the lower stopband can be

introduced to get high attenuation. Meanwhile, better spurious suppression performance is achieved. A filter sample was fabricated with multi-layer LTCC technology to validate the design.

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